

14A, 500V N-CHANNEL POWER MOSFET

■ DESCRIPTION

The UTC **14N50** is a N-Channel enhancement mode power MOSFET. The device adopts planar stripe and uses DMOS technology to minimize and provide lower on-state resistance and faster switching speed. It can also withstand high energy pulse under the avalanche and commutation mode conditions.

The UTC **14N50** is ideally suitable for high efficiency switch mode power supply, power factor correction and electronic lamp ballast based on half bridge topology.



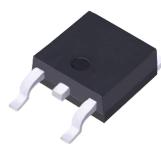
TO-220



TO-220F



TO-262



TO-263



TO-251



TO-252

14N50

Power MOSFET

■ ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage	V_{DSS}	500	V	
Gate-Source Voltage	V_{GSS}	± 30	V	
Continuous Drain Current	I_D	14	A	
Pulsed Drain Current (Note 2)	I_{DM}	48	A	
Avalanche Current (Note 2)	I_{AR}	14	A	
Single Pulsed Avalanche Energy (Note 3)	E_{AS}	400	mJ	
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns	
Power Dissipation ($T_c=25^\circ\text{C}$)	TO-220	P_D	150	W
	TO-220F1		50	W
	TO-263		150	W
Junction Temperature	T_J	+150	$^\circ\text{C}$	
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. $L = 9.3\text{mH}$, $I_{AS} = 13\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 13\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	62.5	$^\circ\text{C/W}$	
Junction to Case	TO-220	θ_{JC}	0.83	$^\circ\text{C/W}$
	TO-220F1		2.5	$^\circ\text{C/W}$
	TO-263		0.83	$^\circ\text{C/W}$

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■ ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 1\text{mA}$	500			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 500\text{V}, V_{\text{GS}} = 0\text{V}$		10		μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$ $V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		100	nA	
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}}=250\text{mA}$, Referenced to 25°C	0.5			$\text{V}/^\circ\text{C}$
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 100\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 7.0\text{A}$			0.50	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V},$ $f=1.0\text{MHz}$		2000		pF
Output Capacitance	C_{OSS}			238		pF
Reverse Transfer Capacitance	C_{RSS}			55		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge	Q_G	$V_{\text{DS}}=400\text{V}, I_{\text{D}}=12\text{A},$ $V_{\text{GS}}=10\text{V}$ (Note 1,2)		69	92	nC
Gate-Source Charge	Q_{GS}			12		nC
Gate-Drain Charge	Q_{GD}			31		nC
Turn-On Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DD}} = 250\text{V}, I_{\text{D}} = 14\text{A},$ $R_G = 25\Omega$ (Note 1,2)		24		nS
Turn-On Rise Time	t_R			70		nS
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			54		nS
Turn-Off Fall Time	t_F			50		nS
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-Source Diode Forward Voltage	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 14\text{A}$			1.6	V
Maximum Continuous Drain-Source Diode Forward Current	I_{S}				14	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				56	A
Reverse Recovery Time	t_{rr}	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 14\text{A},$ $dI_F / dt = 100\text{A}/\mu\text{s}$ (Note 1)		470		nS
Reverse Recovery Charge	Q_{RR}			3.1		μC

Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating ambient temperature.

■ TYPICAL CHARACTERISTICS